ASSOCIATION CONNECTING LECTRONICS INDUSTRIES INDUSTRIES	nockburn, Illinois, A	Il rights reserved untions.	under both	This docume level parts, th	ent is a declaration er	n of the sub compasses	ostances w all lower l	vithin the manufactur level materials for wh	er listed ite	m. Note: if nufacturer	the item is an as has engineering	sembly with lower responsibility.	
	.1 IPC Web Site for Information on IPC-1752 Standard Form Type Distribute			*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information								
Supplier Information													
Company name*	apany name* Company unique ID			Unique ID Authority					Response Date*				
onsemi										2025-06-08			
Contact Name	Title - Contact			1	Phone - Contact*				Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*	horized Representative* Title - Representative			1	Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compliance				NA	Α			Product-Env-Stewards@onsemi.com					
Requester Item Number Mf	r Item Number	Mfr Item Name			Effective Date	Version	Ma	anufacturing Site	W	eight*	UOM	Unit Type	
NV W0	MJS1D6N06CLT	IJS1D6N06CLT T6 60V LL LFPAK			2025-06-08		PE	РВВ		9.445	mg	Each	
Manufacturing Proccess Information													
Terminal Plating / Grid Array Material	Terminal Base Alloy J-S		J-STD-020 MSL	Rating	Peak Proce	ss Body Ter	Body Temperature Max Time at Peak		Temperatu	e Numbe	er of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	second	3 3			
Comments													
level 1 - maximum time at peak temperature duri	ng soldering is 10-3	0 seconds											
For more information regarding material compos	sition please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, is of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified information. However, in situations where Supplier has not ndependently verified information provided by others, Supplier agrees that, at a minimum, itsuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the sertification in this paragraph. If the Company and the Supplier into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of hat agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature	astislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	6.9	mg	Supplier	Iron (Fe)	7439-89-6		0.0083	mg
			Supplier	Copper (Cu)	7440-50-8		6.8896	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0021	mg
Die	1.1	mg	Supplier	Silicon (Si)	7440-21-3		1.1	mg
Lead Frame	36.7	mg	Supplier	Silver (Ag)	7440-22-4		0.0037	mg
			Supplier	Iron (Fe)	7439-89-6		0.044	mg
			Supplier	Copper (Cu)	7440-50-8		36.6413	mg
			Supplier	Phosphorus (P)	7723-14-0		0.011	mg
Mold Compound-Black	41.4	mg	Supplier	Trimethoxysilylpropanethiol	4420-74-0		0.207	mg
			Supplier	Boron zinc hydroxide oxide	138265-88-0		6.21	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		6.21	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1035	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		26.3925	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.277	mg
lating	6.3	mg	Supplier	Tin (Sn)	7440-31-5		6.3	mg
Solder Paste	7.0	mg	Supplier	Silver (Ag)	7440-22-4		0.175	mg
			А	Lead (Pb)	7439-92-1	7a	6.475	mg
			Supplier	Tin (Sn)	7440-31-5		0.35	mg
Wire Bond - Cu	0.045	mg	Supplier	Copper (Cu)	7440-50-8		0.045	mg